



# Product Change Notification

**Change Notification #:** 114775 - 00  
**Change Title:** Intel® Server Board S2600WT2R,  
Intel® Server Board S2600WTTR,  
PCN 114775 - 00,  
Product Material, Product Design  
Replacement of components under RoHS  
exemptions and Updated  
BIOS/ME/BMC/FRUSDR Firmware  
**Date of Publication:** July 18, 2016

**Key Characteristics of the Change:**  
Product Material, Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	<b>July 18, 2016</b>
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## Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Boards S2600WT2R and S2600WTTR:

1. Replacement of components containing substances listed under EU RoHS exemption 6(c), 7(c), 15 and one component containing substances listed under EU RoHS exemption 7(a). All new components are identical in form factor and function to the replaced ones.

<b>Product Code</b>	<b>Exemptions Replaced</b>	<b>Exemptions Remaining</b>
S2600WT2R	6(c), 7(c)-I, 7(a) (one IC)	7(a)
S2600WTTR	6(c), 7(c)-I, 7(a) (one IC), 15	7(a)

2. Update of the System Firmware installed at the Factory:
  - a. Update the BIOS from revision R01.01.0014 to revision R01.01.0016.
  - b. Update the Manageability Engine (ME) firmware from revision 03.01.03.005 to revision 03.01.03.021.
  - c. Update the Integrated Baseboard Management Controller (BMC) firmware from revision 1.13.8932 to revision 01.43.9685.
  - d. Update the FRUSDR from revision 1.11 to revision 1.13

The system software update package, including the release notes for each, is available for download from <http://www.intel.com/support>. Please refer to the software release notes for a list of changes.

**Customer Impact of Change and Recommended Action:**

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre TA#	Post TA#	Pre-PBA	Post-PBA
S2600WT2R	943786	H79749-002	H79749-003	H21573-366	H21573-371
S2600WTTR	943785	H79751-003	H79751-004	G92187-367	G92187-371

**PCN Revision History:**

**Date of Revision:**

July 18, 2016

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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